# XN04212 (XN4212)

## Silicon NPN epitaxial planer transistor

### For switching/digital circuits

#### Features

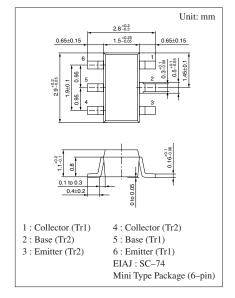
- Two elements incorporated into one package. (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

## Basic Part Number of Element

• UNR1212 (UN1212)× 2 elements

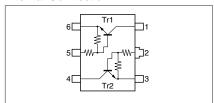
## Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit
Rating of element	Collector to base voltage	$V_{CBO}$	50	V
	Collector to emitter voltage	$V_{CEO}$	50	V
	Collector current	$I_{C}$	100	mA
Overall	Total power dissipation	$P_{T}$	300	mW
	Junction temperature	$T_{j}$	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



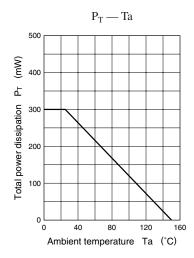
Marking Symbol: 8R

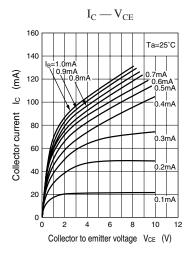
#### Internal Connection

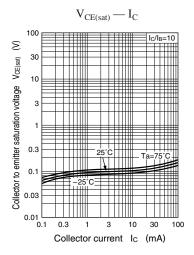


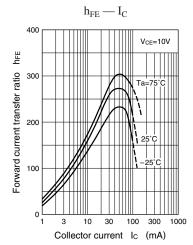
#### Electrical Characteristics (Ta=25°C)

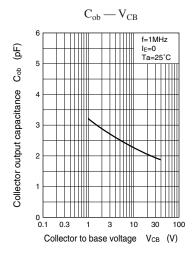
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = 10 \mu A, I_{\rm E} = 0$	50			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = 2mA, I_{\rm B} = 0$	50			V
C-11	$I_{CBO}$	$V_{CB} = 50V, I_{E} = 0$			0.1	μΑ
Collector cutoff current	$I_{CEO}$	$V_{CE} = 50V, I_B = 0$			0.5	μΑ
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 6V, I_{C} = 0$			0.2	mA
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10V, I_{C} = 5mA$	60			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 10 \text{mA}, I_{\rm B} = 0.3 \text{mA}$			0.25	V
Output voltage high level	V <sub>OH</sub>	$V_{CC} = 5V, V_{B} = 0.5V, R_{L} = 1k\Omega$	4.9			V
Output voltage low level	V <sub>OL</sub>	$V_{CC} = 5V, V_{B} = 2.5V, R_{L} = 1k\Omega$			0.2	V
Transition frequency	$f_T$	$V_{CB} = 10V, I_{E} = -1mA, f = 200MHz$		150		MHz
Input resistance	R <sub>1</sub>		-30%	22	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.8	1.0	1.2	

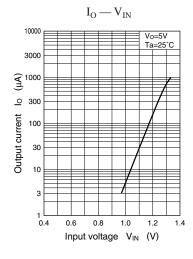


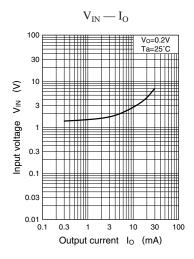












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